



## VN1706B, VN1706D

N-Channel Enhancement-Mode MOS Transistors

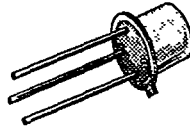
T-39-05

### PRODUCT SUMMARY

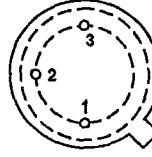
PART NUMBER	V <sub>(BR)DSS</sub> (V)	r <sub>DS(ON)</sub> (Ω)	I <sub>D</sub> (A)	PACKAGE
VN1706B	170	6	0.63	TO-205AD
VN1706D	170	6	1.12	TO-220

Performance Curves: VNDB24 (See Section 7)

TO-205AD (TO-39)



BOTTOM VIEW



- 1 SOURCE
- 2 GATE
- 3 DRAIN & CASE

TO-220



TOP VIEW



- 1 GATE
- 2 & TAB - DRAIN
- 3 SOURCE

### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C unless otherwise noted)

PARAMETERS/TEST CONDITIONS	SYMBOL	VN1706B	VN1706D	UNITS
Drain-Source Voltage	V <sub>DS</sub>	170	170	V
Gate-Source Voltage	V <sub>GS</sub>	±20	±30	
Continuous Drain Current	I <sub>D</sub>	T <sub>C</sub> = 25°C	0.63	A
		T <sub>C</sub> = 100°C	0.4	
Pulsed Drain Current <sup>1</sup>	I <sub>DM</sub>	3	3	
Power Dissipation	P <sub>D</sub>	T <sub>C</sub> = 25°C	6.25	W
		T <sub>C</sub> = 100°C	2.5	
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C
Lead Temperature (1/16" from case for 10 seconds)	T <sub>L</sub>	300		

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### THERMAL RESISTANCE

THERMAL RESISTANCE	SYMBOL	VN1706B	VN1706D	UNITS
Junction-to-Ambient	R <sub>thJA</sub>	170	80	°C/W

<sup>1</sup>Pulse width limited by maximum junction temperature

## VN1706B, VN1706D

T-39-05



ELECTRICAL CHARACTERISTICS <sup>1</sup>			LIMITS			
PARAMETER	SYMBOL	TEST CONDITIONS	VN1706			UNIT
			TYP <sup>2</sup>	MIN	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 100\ \mu\text{A}$	230	170		V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1\text{ mA}$	1.4	0.8	2.0	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0\text{ V}$ $V_{GS} = \pm 15\text{ V}$ $T_C = 125^\circ\text{C}$	$\pm 1$ $\pm 5$		$\pm 100$ $\pm 500$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 120\text{ V}$ $V_{GS} = 0\text{ V}$ $T_C = 125^\circ\text{C}$	0.01 1		10 500	$\mu\text{A}$
On-State Drain Current <sup>3</sup>	$I_{D(ON)}$	$V_{DS} = 10\text{ V}, V_{GS} = 10\text{ V}$	1.5	1		A
Drain-Source On-Resistance <sup>3</sup>	$r_{DS(ON)}$	$V_{GS} = 2.5\text{ V}, I_D = 0.1\text{ A}$	7.5		10	$\Omega$
		$V_{GS} = 10\text{ V}$ $I_D = 0.5\text{ V}$ $T_C = 125^\circ\text{C}$	5 10.8		6 14.8	
Forward Transconductance <sup>3</sup>	$g_{FS}$	$V_{DS} = 10\text{ V}, I_D = 0.5\text{ A}$	530	300		mS
Common Source Output Conductance <sup>3</sup>	$g_{OS}$	$V_{DS} = 7.5\text{ V}, I_D = 0.5\text{ A}$	475			$\mu\text{S}$
<b>DYNAMIC</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 25\text{ V}$ $V_{GS} = 0\text{ V}$ $f = 1\text{ MHz}$	105		125	pF
Output Capacitance	$C_{oss}$		25		50	
Reverse Transfer Capacitance	$C_{rss}$		5		20	
<b>SWITCHING</b>						
Turn-On Time	$t_{d(ON)}$	$V_{DD} = 60\text{ V}, R_L = 150\ \Omega$ $I_D = 0.4\text{ A}, V_{GEN} = 10\text{ V}$ $R_G = 25\ \Omega$  (Switching time is essentially independent of operating temperature)	3		8	ns
	$t_r$		2		8	
Turn-Off Time	$t_{d(OFF)}$		13		18	
	$t_f$		9		12	

- NOTES: 1.  $T_C = 25^\circ\text{C}$  unless otherwise noted.  
 2. For design aid only, not subject to production testing.  
 3. Pulse test;  $PW = 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ .